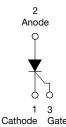


Thyristor High Voltage, Surface Mountable Phase Control SCR, 16 A





TO-263AB (D²PAK)

PRODUCT SUMMARY				
Package	TO-263AB (D ² PAK)			
Diode variation	Single SCR			
I _{T(AV)}	10 A			
V_{DRM}/V_{RRM}	800 V, 1200 V			
V_{TM}	1.4 V			
I _{GT}	60 mA			
TJ	- 40 °C to 125 °C			

FEATURES

- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Designed and qualified according JEDEC-JESD47
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition





ROHS

HALOGEN FREE

APPLICATIONS

- Input rectification (soft start)
- Vishay input diodes, switches and output rectifiers which are available in identical package outlines

DESCRIPTION

The VS-16TTS..SPbF high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS						
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS						
NEMA FR-4 or G-10 glass fabric-based epoxy with 4 oz. (140 μm) copper	2.5	3.5				
Aluminum IMS, R _{thCA} = 15 °C/W	6.3	A				
Aluminum IMS with heatsink, R _{thCA} = 5 °C/W	14.0	18.5				

Note

• T_A = 55 °C, T_J = 125 °C, footprint 300 mm²

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	CHARACTERISTICS VALUES			
I _{T(AV)}	Sinusoidal waveform	10	Λ.		
I _{RMS}		16	A		
V _{RRM} /V _{DRM}		800/1200	V		
I _{TSM}		200	A		
V _T	10 A, T _J = 25 °C	1.4	V		
dV/dt		500	V/µs		
dl/dt		150	A/µs		
TJ		- 40 to 125	°C		

VOLTAGE RATINGS						
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA			
VS-16TTS08SPbF	800	800	10			
VS-16TTS12SPbF	1200	1200	10			



ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
PARAMETER	STIVIBUL	TEST CONDITIONS	TYP. MAX.	UNITS		
Maximum average on-state current	I _{T(AV)}	$T_C = 98$ °C, 180° conduction, half sine wave	10			
Maximum RMS on-state current	I _{RMS}		16	Α		
Maximum peak, one-cycle,		10 ms sine pulse, rated V _{RRM} applied	170	A .		
non-repetitive surge current	I _{TSM}	10 ms sine pulse, no voltage reapplied	200			
Maximum I ² t for fusing	I2t	10 ms sine pulse, rated V _{RRM} applied	144	A ² s		
	1-1	10 ms sine pulse, no voltage reapplied	200	A-5		
Maximum I ² √t for fusing	I ² √t	t = 0.1 ms to 10 ms, no voltage reapplied	2000	A²√s		
Maximum on-state voltage drop	V _{TM}	10 A, T _J = 25 °C	1.4	V		
On-state slope resistance	r _t	T 105 °C	24.0	mΩ		
Threshold voltage	V _{T(TO)}	T _J = 125 °C	1.1	V		
Maximum various and direct lackage current	1 //	T _J = 25 °C	0.5			
Maximum reverse and direct leakage current	I _{RM} /I _{DM}	$T_J = 125 ^{\circ}\text{C}$ $V_R = \text{Rated } V_{RRM} / V_{DRM}$	10	A		
Holding current	I _H	Anode supply = 6 V, resistive load, initial I _T = 1 A		mA		
Maximum latching current	ΙL	Anode supply = 6 V, resistive load	200			
Maximum rate of rise of off-state voltage	dV/dt		500	V/µs		
Maximum rate of rise of turned-on current	dl/dt		150	A/µs		

TRIGGERING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum peak gate power	P _{GM}		8.0	W		
Maximum average gate power	P _{G(AV)}		2.0	VV		
Maximum peak positive gate current	+ I _{GM}		1.5	Α		
Maximum peak negative gate voltage	- V _{GM}		10	V		
	I _{GT}	Anode supply = 6 V, resistive load, T _J = - 10 °C	90	mA		
Maximum required DC gate current to trigger		Anode supply = 6 V, resistive load, T _J = 25 °C	60			
		Anode supply = 6 V, resistive load, T _J = 125 °C	35			
		Anode supply = 6 V, resistive load, T _J = - 10 °C	3.0			
Maximum required DC gate voltage to trigger	V_{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	2.0	V		
		Anode supply = 6 V, resistive load, T _J = 125 °C	1.0	V		
Maximum DC gate voltage not to trigger	V_{GD}	T = 195 °C V = Peted value	0.25			
Maximum DC gate current not to trigger	I _{GD}	T _J = 125 °C, V _{DRM} = Rated value		mA		

SWITCHING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Typical turn-on time	t _{gt}	T _J = 25 °C	0.9		
Typical reverse recovery time	t _{rr}	T. _I = 125 °C	4	μs	
Typical turn-off time	t _q	11 = 120 0	110		

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperature range	T _J , T _{Stg}		- 40 to 125	°C		
Soldering temperature	T _S	For 10 s (1.6 mm from case)	240			
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	1.3	°C/W		
Typical thermal resistance, junction to ambient	R _{thJA}	PCB mount (1)	40	1 -0/00		
Approximate weight			2	g		
Approximate weight			0.07	oz.		
Moulting daying		Coop at the D2DAK (SMD 220)	16TTS	08S		
Marking device		Case style D ² PAK (SMD-220)	16TTS12S			

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W. For recommended footprint and soldering techniques refer to application note #AN-994.

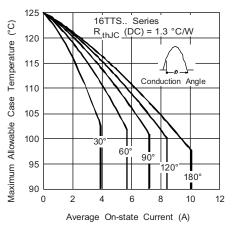


Fig. 1 - Current Rating Characteristics

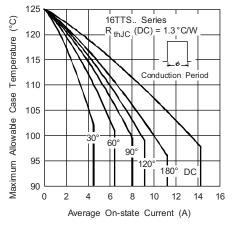


Fig. 2 - Current Rating Characteristics

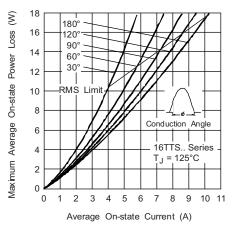


Fig. 3 - On-State Power Loss Characteristics

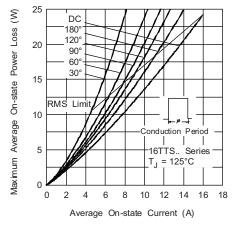


Fig. 4 - On-State Power Loss Characteristics

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Vishay Semiconductors

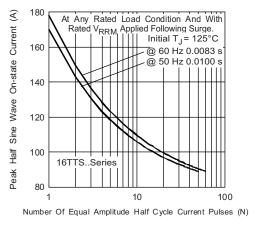


Fig. 5 - Maximum Non-Repetitive Surge Current

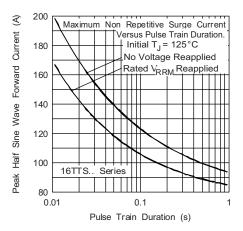


Fig. 6 - Maximum Non-Repetitive Surge Current

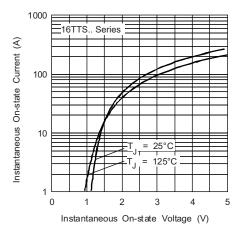


Fig. 7 - On-State Voltage Drop Characteristics

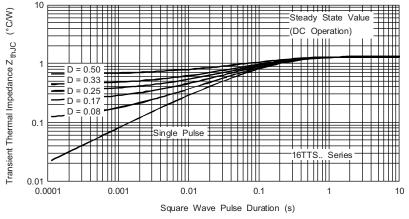


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

08 = 800 V

12 = 1200 V

Vishay Semiconductors

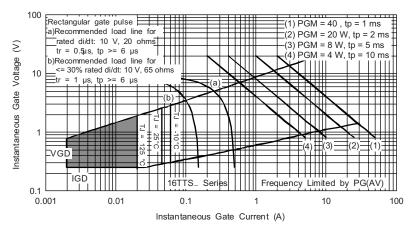
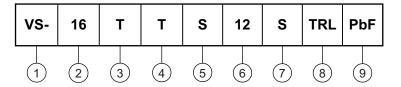


Fig. 9 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating

3 - Circuit configuration:

T = Single thyristor

4 - Package:

T = TO-220AC

5 - Type of silicon:

S = Standard recovery rectifier

Voltage rating: Voltage code x 100 = V_{RRM} ——

7 - S = D²PAK version

8 - • None = Tube

• TRL = Tape and reel (left oriented)

• TRR = Tape and reel (right oriented)

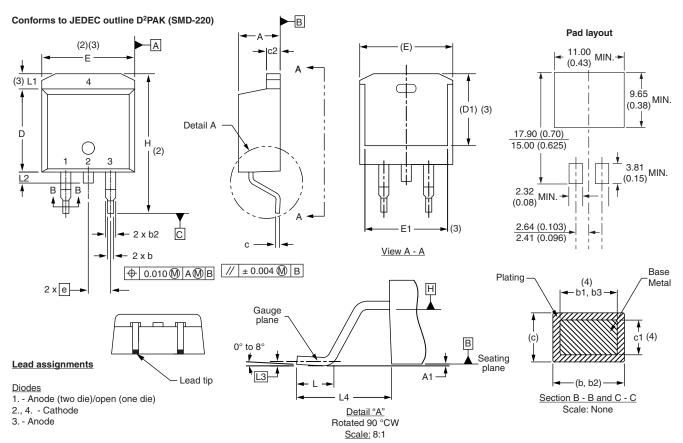
9 - PbF = Lead (Pb)-free and RoHS compliant

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95046			
Part marking information	www.vishay.com/doc?95054			
Packaging information	www.vishay.com/doc?95032			



D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	IETERS	INC	NOTES	
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	ETERS	INCHES		NOTES
STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	1	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

Notes

- $^{(1)}$ Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC outline TO-263AB



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